ΓΑΝΙΧΙΛΙ Fast, Low-Voltage, 4Ω, 4-Channel CMOS Analog Multiplexer

General Description

The MAX4634 fast, low-voltage, 4-channel CMOS analog multiplexer features 4Ω max on-resistance (R_{ON}). It offers R_{ON} matching between switches to 0.3Ω max and R_{ON} flatness of 1Ω max over the specified signal range. Each switch can handle V+ to GND analog signals. Offleakage current is only 0.1nA max at +25°C. The MAX4634 features fast turn-on (t_{ON}) and turn-off (t_{OFF}) times of 18ns and 11ns, respectively. All this comes in the tiny 10-pin µMAX and 12-pin QFN packages.

This low-voltage multiplexer operates from a +1.8V to +5.5V single supply. All digital inputs have +0.8V and +2.4V logic thresholds, ensuring TTL/CMOS-logic compatibility with +5V operation.

_Features

- Guaranteed R_{ON}
 2.5Ω typ (5V Supply)
 4.5Ω typ (3V Supply)
- Guaranteed R_{ON} Match Between Channels 0.3Ω max
- Guaranteed R_{ON} Flatness Over Signal Range 1Ω max
- Guaranteed Low Leakage Currents 0.1nA (at +25°C)
- +1.8V to +5.5V Single-Supply Operation
- +1.8V Operation
 RON = 30Ω typ Over Temperature
 tON = 30ns typ, tOFF = 13ns typ
- V+ to GND Signal Handling
- TTL/CMOS-Logic Compatible
- ◆ -78dB Crosstalk (at 1MHz)
- -80dB Off-Isolation (at 1MHz)
- 0.018% Total Harmonic Distortion

MAX4634

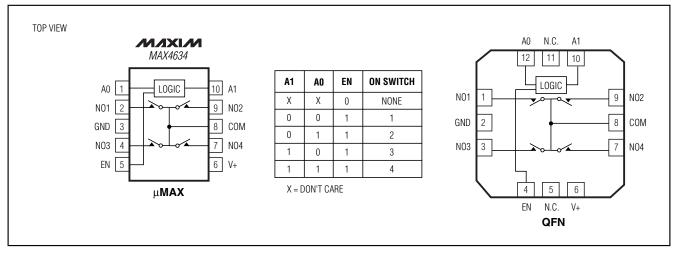
Applications

- Battery-Operated Equipment
- Audio and Video Signal Routing
- Low-Voltage Data-Acquisition Systems
- Sample-and-Hold Circuits
- Communications Circuits

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE
MAX4634EUB	-40°C to +85°C	10 µMAX
MAX4634EGC	-40°C to +85°C	12 QFN (4x4)

Pin Configuration/Functional Diagram/Truth Table



M/X/W

_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND)

V+	0.3V to +6V
A_, EN, COM, NO_ (Note 1)	0.3V to (V+ + 0.3V)
Continuous Current (all other pins)	±20mÅ
Continuous Current (COM, NO_)	±50mA
Peak Current (COM, NO_ pulsed at 1ms,	
10% duty cycle)	±100mA

Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
10-Pin µMAX (derate 4.1mW/°C above +70°C)	/
12-Pin QFN (derate 16.9mW/°C above +70°C)1349mW	/
Operating Temperature Range	
MAX4634EUB40°C to +85°C	;
Storage Temperature Range)
Lead Temperature (soldering, 10s)+300°C	;

Note 1: Signals on NO_, COM, EN, or A_ exceeding V+ or GND are clamped by internal diodes. Limit forward diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

(V+ = +4.5V to +5.5V, V_{IH} = 2.4V, V_{IL} = 0.8V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = +5V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
ANALOG SWITCH				1			
Analog Signal Range	V _{COM} , V _{NO} _			0		V+	V
On-Resistance	Ron	$V_{+} = 4.5V,$ $I_{COM} = 10mA,$	TA = +25°C		2.5	4	Ω
On-nesistance	NON	$V_{NO} = 0$ to V+	$T_A = T_{MIN}$ to T_{MAX}			4.5	
On-Resistance Match Between Channels	ARest	$V_{+} = 4.5V,$	TA = +25°C		0.1	0.3	0
(Notes 3, 8)	ΔR _{ON}	$I_{COM} = 10mA,$ $V_{NO} = 0$ to V+	$T_A = T_{MIN}$ to T_{MAX}			0.4	- Ω
On-Resistance Flatness (Note 4)	RFLAT(ON)	$V_{+} = 4.5V,$ $I_{COM} = 10mA,$ $V_{NO_{-}} = 0 \text{ to } V_{+}$	$T_A = +25^{\circ}C$		0.75	1	- Ω
			TA = TMIN to TMAX			1.2	
NO_ Off-Leakage	I _{NO_(OFF)}	V+ = 5.5V; V _{COM} = 1V, 4.5V; V _{NO} _ = 4.5V, 1V	$T_A = +25^{\circ}C$	-0.1	±0.01	0.1	- nA
Current (Note 5)			TA = TMIN to TMAX	-0.3		0.3	
COM Off-Leakage Current		V+ = 5.5V; V _{COM} = 1V, 4.5V; V _{NO} _ = 4.5V, 1V	$T_A = +25^{\circ}C$	-0.1	±0.01	0.1	~ ^ ^
(Note 5)	ICOM(OFF)		$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	nA
COM On-Leakage Current		V+ = 5.5V; V _{COM} = 1V, 4.5V;	$T_A = +25^{\circ}C$	-0.1	±0.01	0.1	nA
(Note 5)	ICOM(ON)	$V_{NO} = 1V, 4.5V,$ or floating	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	
DIGITAL I/O (A_, EN)							I
Input Logic High	VIH			2.4			V
Input Logic Low	VIL					0.8	V
Input Logic Current				-100	5	100	nA

$\label{eq:Fast, Low-Voltage, 4} \Omega, \\ \mbox{4-Channel CMOS Analog Multiplexer}$

ELECTRICAL CHARACTERISTICS—Single +5V Supply (continued)

(V+ = +4.5V to +5.5V, V_{IH} = 2.4V, V_{IL} = 0.8V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = +5V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
DYNAMIC							
Turn-On Time (Note 5)	ton	$V_{NO_{-}} = 3V,$ $R_{I_{-}} = 300\Omega,$	$T_A = +25^{\circ}C$		14	18	ns
		$C_L = 35 pF$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			20	110
Turn-Off Time (Note 5)	toff	$V_{NO_{-}} = 3V,$ $R_{L} = 300\Omega,$	$T_A = +25^{\circ}C$		6	11	- ns
	UFF	$C_L = 35 pF$, Figure 2	$T_A = T_{MIN}$ to T_{MAX}			13	
Break-Before-Make Time	tBBM	$V_{NO_{-}} = 3V,$ $R_{L} = 300\Omega,$ $C_{L} = 35pF,$ Figure 3	$T_A = +25^{\circ}C$		8		- ns
(Note 5)	¹ BBIM		TA = TMIN to TMAX	1			
Charge Injection	Q	$V_{GEN} = 2V, R_{GEN} = 0,$	$C_L = 5 pF$, Figure 4		2		рС
Off-Isolation (Note 6)	VISO	$C_{L} = 5pF, R_{L} = 50\Omega,$ Figure 5	f = 10MHz		-57		dB
	VISU		f = 1MHz		-80		1 "
Crosstalk (Note 7)	Ver	$C_L = 5pF, R_L = 50\Omega,$ Figure 5	f = 10MHz		-52		- dB
CIUSSIAIK (INULE 7)	VCT		f = 1MHz		-78		
NO_Off-Capacitance	C _{NO_(OFF)}	Figure 6	1		13		pF
COM Off-Capacitance	CCOM(OFF)	Figure 6	Figure 6		52		pF
COM On-Capacitance	CCOM(ON)	CL = 5pF, Figure 6			68		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, f = 20Hz to 20kHz			0.018		%
POWER SUPPLY	1	1					
Power-Supply Range	V+			1.8		5.5	V
Positive Supply Current	I+	V+ = 5.5V, VIH = V+, V	′IL = 0		0.001	1.0	μA

ELECTRICAL CHARACTERISTICS—Single +3V Supply

(V+ = +2.7V to +3.3V, V_{IH} = 2.0V, V_{IL} = 0.4V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = +3V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH	l i						
Analog Signal Range	V _{COM_} , V _{NO_}			0		V+	V
On-Resistance	Devi	$V_{+} = 2.7V,$	$T_A = +25^{\circ}C$		4.5	7	Ω
On-nesistance	R _{ON}	$I_{COM} = 10mA,$ $V_{NO_} = 0 \text{ to V}+$	$T_A = T_{MIN}$ to T_{MAX}			8	
On-Resistance Match Between Channels	ΔR _{ON}	V+ = 2.7V, I _{COM} = 10mA,	$T_A = +25^{\circ}C$		0.1	0.3	Ω
	$V_{NO_{-}} = 0$ to V+ $T_A = T_{MIN}$ to T_{MAX}			0.4			

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

 $(V + = +2.7V \text{ to } +3.3V, V_{IH} = 2.0V, V_{IL} = 0.4V, T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$, unless otherwise noted. Typical values are at V+ = +3V, T_A = +25^{\circ}\text{C}.) (Note 2)

PARAMETER	SYMBOL	COND	ITIONS	MIN	ТҮР	MAX	UNITS
On-Resistance Flatness	Devices	V + = 2.7V, $I_{COM} = 10mA,$ $V_{NO_{-}} = 0 \text{ to } V +$	$T_A = +25^{\circ}C$		1.2	2.5	
(Note 4)	RFLAT(ON)		$T_A = T_{MIN}$ to T_{MAX}			3	Ω
NO_ Off-Leakage Current		$V_{+} = 3.3V;$	T _A = +25°C	-0.1	±0.01	0.1	۳A
(Note 5)	INO_(OFF)	V _{COM} = 1V, 3V; V _{NO} = 3V, 1V	$T_A = T_{MIN}$ to T_{MAX}	-0.3		0.3	nA
COM Off-Leakage Current		V+ = 3.3V; VCOM = 1V, 3V;	$T_A = +25^{\circ}C$	-0.1	±0.01	0.1	nA
(Note 5)	ICOM_(OFF)	$V_{NO} = 3V, 1V$	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	
COM On-Leakage Current		V+ = 3.3V; V _{COM} = 1V, 3V;	$T_A = +25^{\circ}C$	-0.1	±0.01	0.1	
(Note 5)	ICOM_(ON)	$V_{NO} = 1V, 3V, or$ floating	$T_A = T_{MIN}$ to T_{MAX}	-0.65		0.65	- nA
DIGITAL I/O (A_, EN)							
Input High	VIH			2.0			V
Input Low	VIL					0.4	V
Input Logic Current				-100	5	100	nA
DYNAMIC							
Turn-On Time (Note 5)	t _{ON}	$V_{NO_{-}} = 2V,$ $C_{L} = 35pF,$ $R_{L} = 300\Omega,$ Figure 2	$T_A = +25^{\circ}C$		16	22	ns
rum-on nine (Note 3)			$T_A = T_{MIN}$ to T_{MAX}			24	
Turn-Off Time (Note 5)	tOFF	$V_{NO_{-}} = 2V,$ $C_{L} = 35pF,$ $R_{L} = 300\Omega,$ Figure 2	$T_A = +25^{\circ}C$		8	14	ns
rum-on nine (Note 3)			TA = TMIN to TMAX			16	115
Break-Before-Make Time (Note 5)	tBBM	$V_{NO_{-}} = 2V,$ $C_{L} = 35pF,$ $R_{L} = 300\Omega, Figure 3$	$T_A = +25^{\circ}C$		9		ns
	rbbin		$T_A = T_{MIN}$ to T_{MAX}	1			115
Charge Injection	Q	$V_{GEN} = 1.5V, R_{GEN} = 1.5V$	0, $C_L = 5pF$, Figure 4		2		рС
Off-Isolation (Note 6)	Viso	$C_L = 5 pF, R_L = 50 \Omega,$	f = 10MHz		-57		dB
	•150	Figure 5	f = 1MHz		-80		
Crosstalk (Note 7)	VCT	$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-52		dB
	Figure 5	Figure 5	f = 1MHz		-78		

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

(V+ = +2.7V to +3.3V, V_{IH} = 2.0V, V_{IL} = 0.4V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = +3V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		ТҮР	MAX	UNITS
NO_Off-Capacitance	CNO_(OFF)	V _{NO} = GND, f = 1MHz, Figure 6		13		рF
COM Off-Capacitance	CCOM(OFF)	V _{COM} = GND, f = 1MHz, Figure 6		52		рF
COM On-Capacitance	C _(ON)	$V_{COM} = V_{NO} = GND$, f = 1MHz, Figure 6		68		pF
Total Harmonic Distortion	THD	$R_L = 600\Omega$, f = 20Hz to 20kHz		0.018		%
POWER SUPPLY						
Positive Supply Current	I+	$V + = 3.3V, V_{IH} = V +, V_{IL} = 0$		0.001	1	μA

Note 2: The algebraic convention, where the most negative value is a minimum and the most positive value a maximum, is used in this data sheet.

Note 3: $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$.

Note 4: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

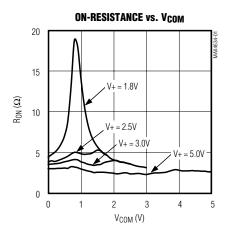
Note 5: Guaranteed by design.

Note 6: Off-Isolation = $20\log_{10} (V_{COM} / V_{NO})$, where V_{COM} = output and V_{NO} = input to off switch.

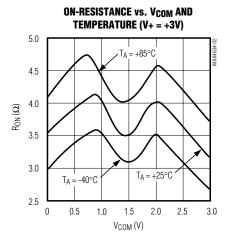
Note 7: Between any two switches.

Note 8: R_{ON} and ΔR_{ON} matching specifications for QFN-packaged parts are guaranteed by design.

 $(T_A = +25^{\circ}C, unless otherwise noted.)$



Typical Operating Characteristics



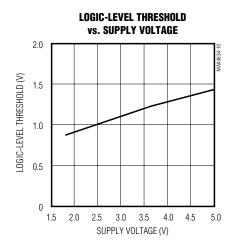
Typical Operating Characteristics (continued) $(T_A = +25^{\circ}C, unless otherwise noted.)$ **ON-RESISTANCE vs. V**COM AND **ON/OFF-LEAKAGE CURRENT** vs. TEMPERATURE **TEMPERATURE (V+ = +5V)** 4.0 0.15 0.10 3.5 T_A = +85°C ICOM(OFF) LEAKAGE (nA) 0 3.0 $R_{ON}(\Omega)$ 2.5 I_{NO_(OFF)} 2.0 -0.05 ICOM(ON) $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ -0.10 1.5 1 2 4 -50 0 50 100 0 3 5 V_{COM} (V) TEMPERATURE (°C) **ON/OFF-ENABLE TIME** CHARGE INJECTION vs. V_{COM} vs. SUPPLY VOLTAGE 35 2.5 30 V+ = 5V 2.0 25 ton/torF (ns) 1.5 20 Q (pC) ton = 3V 15 1.0 10 torF 0.5 5 0 0 2.0 2.5 4.5 1.5 3.0 3.5 4.0 5.0 0 2 3 5 1 4 SUPPLY VOLTAGE (V) V_{COM} (V) **ON/OFF-ENABLE TIME POWER-SUPPLY CURRENT** vs. TEMPERATURE vs. TEMPERATURE 0.5 12 10 0.4 ton 8 l+, l_{GND} (μA) ton/toff (ns) 0.3 6 torr 0.2 4 0.1 2 0 0 -50 100 50 -50 100 150 0 0 50 TEMPERATURE (°C) TEMPERATURE (°C)

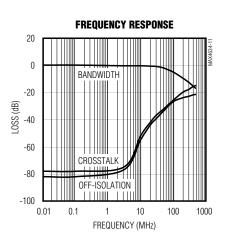
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Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, unless otherwise noted.)$





Pin Description

P	IN	NAME	FUNCTION
μΜΑΧ	QFN	NAME	FUNCTION
1	12	AO	Address Input
2	1	NO1	Normally Open Switch 1
3	2	GND	Ground
4	3	NO3	Normally Open Switch 3
5	4	EN	Enable Logic Input
6	6	V+	Positive Supply Voltage
7	7	NO4	Normally Open Switch 4
8	8	COM	Analog Switch Common Terminal
9	9	NO2	Normally Open Switch 2
10	10	A1	Address Input
_	5, 11	N.C.	No Connection

Detailed Description

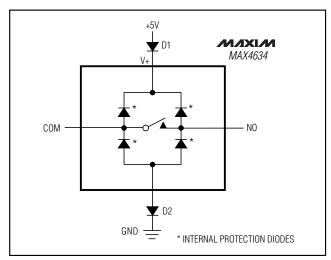
The MAX4634 is a low-on-resistance, low-voltage analog multiplexer that operates from a +1.8V to +5.5V single supply. CMOS switch construction allows processing of analog signals that are within the supply voltage range (GND to V+).

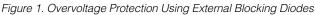
To disable all switch channels, drive EN low. All four inputs and COM become high impedance during this state. If the disable feature is not needed, connect EN to V+.

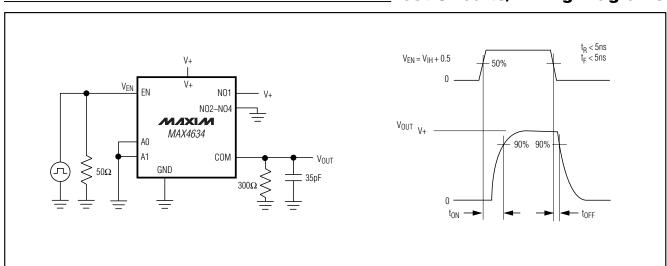
Applications Information

Power-Supply Sequencing and Overvoltage Protection

Proper power-supply sequencing is recommended for all CMOS devices. Always apply V+ before applying analog signals or logic inputs, especially if the analog or logic signals are not current limited. If this sequencing is not possible, and if the analog or logic inputs are not current limited to < 20mA, add a small-signal diode (D1) as shown in Figure 1. If the analog signal can dip below GND, add D2. Adding protection diodes reduces the analog signal range to a diode drop (about 0.7V) below V+ for D1 or to a diode drop above ground for D2. The addition of diodes does not affect leakage. On-resistance increases by a small amount at low supply voltages. Maximum supply voltage (V+) must not exceed 6V. Protection diodes D1 and D2 also protect against some overvoltage situations. A fault voltage up to the absolute maximum rating at an analog signal input does not damage the device, even if the supply voltage is below the signal voltage.







Test Circuits/Timing Diagrams

Figure 2. Switching Time

_Test Circuits/Timing Diagrams (continued)

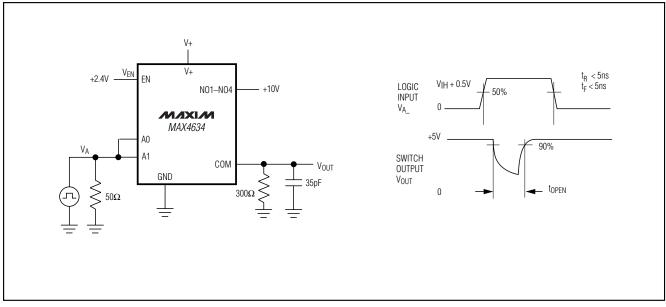


Figure 3. Break-Before-Make Interval

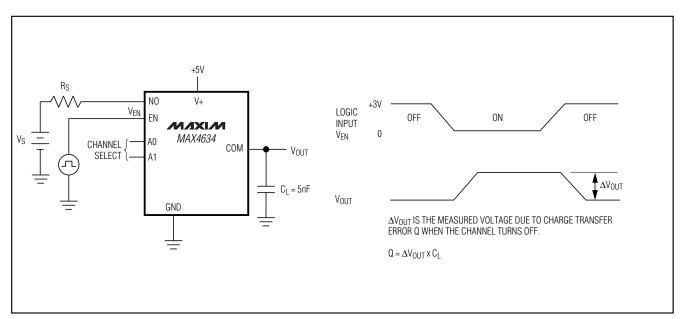
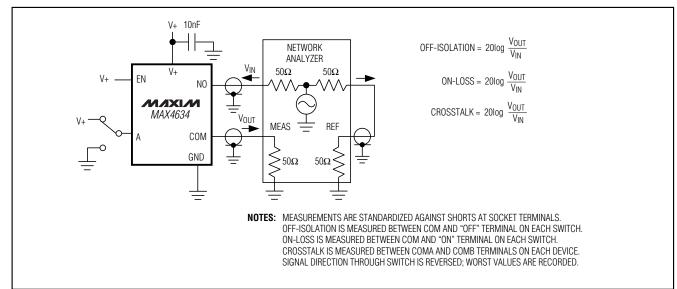


Figure 4. Charge Injection





Test Circuits/Timing Diagrams (continued)

Figure 5. Off-Isolation/On-Channel Bandwidth

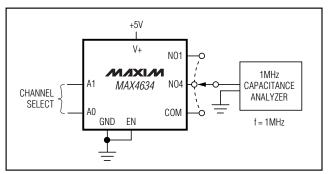


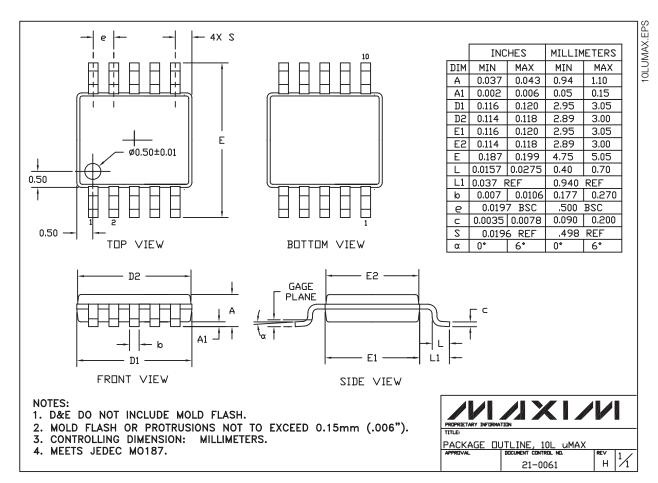
Figure 6. Channel Off/On-Capacitance

Chip Information

TRANSISTOR COUNT: 231

Package Information

MAX4634



Note: The MAX4634 package does not have an exposed pad.

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